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TS5A3359

## FEATURES

- Isolation in Power-Down Mode, $\mathrm{V}_{+}=0$
- Specified Break-Before-Make Switching
- Low ON-State Resistance ( $1 \Omega$ )
- Control Inputs Are 5.5-V Tolerant
- Low Charge Injection
- Excellent ON-State Resistance Matching
- Low Total Harmonic Distortion (THD)
- $1.65-\mathrm{V}$ to $5.5-\mathrm{V}$ Single-Supply Operation
- Latch-Up Performance Exceeds 100 mA Per JESD 78, Class II
- ESD Performance Tested Per JESD 22
- 2000-V Human-Body Model (A114-B, Class II)
- 1000-V Charged-Device Model (C101)


## APPLICATIONS

- Cell Phones
- PDAs
- Portable Instrumentation
- Audio and Video Signal Routing
- Low-Voltage Data Acquisition Systems
- Communication Circuits
- Modems
- Hard Drives
- Computer Peripherals
- Wireless Terminals and Peripherals


FUNCTION TABLE

| IN2 | IN1 | COM TO NO, <br> NO TO COM |
| :---: | :---: | :---: |
| L | L | OFF |
| L | $H$ | COM $=$ NOO |
| $H$ | L | $C O M=$ NO1 |
| $H$ | $H$ | $C O M=$ NO2 |

## DESCRIPTION/ORDERING INFORMATION

The TS5A3359 is a single-pole triple-throw (SP3T) analog switch that is designed to operate from 1.65 V to 5.5 V. The device offers a low ON-state resistance and excellent ON-state resistance matching with the break-before-make feature, to prevent signal distortion during the transferring of a signal from one channel to another. The device has an excellent total harmonic distortion (THD) performance and consumes very low power. These features make this device suitable for portable audio applications.

## ORDERING INFORMATION

| $\mathrm{T}_{\text {A }}$ | PACKAGE ${ }^{(1)(2)}$ |  | ORDERABLE PART NUMBER | TOP-SIDE MARKING ${ }^{(3)}$ |
| :---: | :---: | :---: | :---: | :---: |
| $-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$ | NanoFree ${ }^{\text {TM }}$ - WCSP (DSBGA) 0.23-mm Large Bump - YZP (Pb-free) | Tape and reel | TS5A3359YZPR | _ _ _J9_ |
|  | VSSOP - DCU | Tape and reel | TS5A3359DCUR | JAL |

(1) Package drawings, thermal data, and symbolization are available at www.ti.com/packaging.
(2) For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI website at WWW.ti.com
(3) DCU: The actual top-side marking has one additional character that designates the assembly/test site.

YZP: The actual top-side marking has three preceding characters to denote year, month, and sequence code, and one following character to designate the assembly/test site. Pin 1 identifier indicates solder-bump composition ( $1=\mathrm{SnPb}, \bullet=\mathrm{Pb}$-free).

Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet. NanoFree is a trademark of Texas Instruments.

Summary of Characteristics ${ }^{(1)}$

| Configuration | Triple 3:1 Multiplexer/ Demultiplexer ( $1 \times$ SP3T) |
| :---: | :---: |
| Number of channels | 1 |
| ON-state resistance ( $\mathrm{r}_{\text {on }}$ ) | $1.1 \Omega$ |
| ON-state resistance match ( $\Delta r_{\text {on }}$ ) | $0.1 \Omega$ |
| ON-state resistance flatness ( $\mathrm{r}_{\text {on(flat) }}$ ) | $0.15 \Omega$ |
| Turn-on/turn-off time (ton/toff) | $40 \mathrm{~ns} / 35 \mathrm{~ns}$ |
| Break-before-make time ( $\mathrm{t}_{\mathrm{BBM}}$ ) | 1 ns |
| Charge injection ( $\mathrm{Q}_{\mathrm{C}}$ ) | 40 pC |
| Bandwidth (BW) | 100 MHz |
| OFF isolation ( $\mathrm{O}_{\text {ISO }}$ ) | -65 dB at 10 MHz |
| Crosstalk ( $\mathrm{X}_{\text {TALK }}$ ) | -66 dB at 10 MHz |
| Total harmonic distortion (THD) | 0.01\% |
| Leakage current ( $\mathrm{I}_{\text {COM (OFF) }} / \mathrm{I}_{\text {NO(OFF) }}$ ) | $\pm 20 \mu \mathrm{~A}$ |
| Power supply current ( $\mathrm{I}_{+}$) | $0.1 \mu \mathrm{~A}$ |
| Package options | 8-pin DCU or YZP |

(1) $\mathrm{V}_{+}=5 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$

## ABSOLUTE MINIMUM AND MAXIMUM RATINGS ${ }^{(1)(2)}$

over operating free-air temperature range (unless otherwise noted)

|  |  |  | MIN | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{+}$ | Supply voltage range ${ }^{(3)}$ |  | -0.5 | 6.5 | V |
| $\mathrm{V}_{\mathrm{NO}}$ <br> $\mathrm{V}_{\mathrm{COM}}$ | Analog voltage range ${ }^{(3)(4)(5)}$ |  | -0.5 | $V_{+}+0.5$ | V |
| $\mathrm{I}_{\mathrm{K}}$ | Analog port diode current | $\mathrm{V}_{\mathrm{NO}}, \mathrm{V}_{\mathrm{COM}}<0$ | -50 |  | mA |
| $I_{\mathrm{NO}}$Ícom | On-state switch current | $\mathrm{V}_{\mathrm{NO}}, \mathrm{V}_{\mathrm{COM}}=0$ to $\mathrm{V}_{+}$ | -200 | 200 | mA |
|  |  |  | -400 | 400 |  |
| $\mathrm{V}_{1}$ | Digital input voltage range ${ }^{(3)(4)}$ |  | -0.5 | 6.5 | V |
| $\mathrm{I}_{\mathrm{IK}}$ | Digital input clamp current | $\mathrm{V}_{1}<0$ | -50 |  | mA |
| $I_{+}$ | Continuous current through $\mathrm{V}_{+}$ |  |  | 100 | mA |
| $\mathrm{I}_{\text {GND }}$ | Continuous current through GND |  | -100 | 100 | mA |
| $\mathrm{T}_{\text {stg }}$ | Storage temperature range |  | -65 | 150 | ${ }^{\circ} \mathrm{C}$ |

(1) Stresses above these ratings may cause permanent damage. Exposure to absolute maximum conditions for extended periods may degrade device reliability. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those specified is not implied.
(2) The algebraic convention, whereby the most negative value is a minimum and the most positive value is a maximum
(3) All voltages are with respect to ground, unless otherwise specified.
(4) The input and output voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
(5) This value is limited to 5.5 V maximum.

## PACKAGE THERMAL IMPEDANCE

|  |  |  | UNIT |
| :---: | :---: | :---: | :---: |
| Package thermal impedance ${ }^{(1)}$ | DCU package | 227 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
|  | YZP package | 140 |  |

(1) The package thermal impedance is calculated in accordance with JESD 51-7.

## ELECTRICAL CHARACTERISTICS FOR 5-V SUPPLY ${ }^{(1)}$

$\mathrm{V}_{+}=4.5 \mathrm{~V}$ to $5.5 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$ (unless otherwise noted)

| PARAMETER | SYMBOL | TEST CONDITIONS |  | TA | $\mathrm{V}_{+}$ | MIN | TYP MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Analog Switch |  |  |  |  |  |  |  |  |
| Analog signal range | $\mathrm{V}_{\text {COM }}, \mathrm{V}_{\text {NO }}$ |  |  |  |  | 0 | $V_{+}$ | V |
| Peak ON resistance | $\mathrm{r}_{\text {peak }}$ | $\begin{aligned} & 0 \leq\left(\mathrm{V}_{\mathrm{NO}}\right) \leq \mathrm{V}_{+}, \\ & \mathrm{I}_{\mathrm{COM}}=-100 \mathrm{~mA}, \end{aligned}$ | Switch ON, See Figure 19 | $25^{\circ} \mathrm{C}$ | 4.5 V |  | $0.8 \quad 1.1$ | $\Omega$ |
|  |  |  |  | Full |  |  | 1.5 |  |
| ON-state resistance | $r_{\text {on }}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{NO}}=2.5 \mathrm{~V}, \\ & \mathrm{I}_{\mathrm{COM}}=-100 \mathrm{~mA}, \end{aligned}$ | Switch ON, See Figure 19 | $25^{\circ} \mathrm{C}$ | 4.5 V |  | $0.7 \quad 0.9$ | $\Omega$ |
|  |  |  |  | Full |  |  | 1.1 |  |
| ON-state resistance match between channels | $\Delta r_{\text {on }}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{NO}}=2.5 \mathrm{~V}, \\ & \mathrm{I}_{\mathrm{COM}}=-100 \mathrm{~mA}, \end{aligned}$ | Switch ON, See Figure 19 | $25^{\circ} \mathrm{C}$ | 4.5 V |  | 0.10 .1 | $\Omega$ |
|  |  |  |  | Full |  |  | 0.1 |  |
| ON-state resistance flatness | $\mathrm{r}_{\text {on(flat) }}$ | $\begin{aligned} & 0 \leq\left(\mathrm{V}_{\mathrm{NO}}\right) \leq \mathrm{V}_{+}, \\ & \mathrm{I}_{\mathrm{COM}}=-100 \mathrm{~mA}, \end{aligned}$ | Switch ON, See Figure 19 | $25^{\circ} \mathrm{C}$ | 4.5 V | 0.15 |  | $\Omega$ |
|  |  | $\begin{aligned} & \mathrm{V}_{\mathrm{NO}}=1 \mathrm{~V}, 1.5 \mathrm{~V}, 2.5 \\ & \mathrm{~V}, \\ & \mathrm{I}_{\text {COM }}=-100 \mathrm{~mA}, \end{aligned}$ | Switch ON, See Figure 19 | $25^{\circ} \mathrm{C}$ |  |  | 0.10 .25 |  |
|  |  |  |  | Full |  |  | 0.25 |  |
| NO OFF leakage current | $\mathrm{I}_{\text {NO(OFF) }}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{NO}}=1 \mathrm{~V} \text { or } 4.5 \mathrm{~V}, \\ & \mathrm{~V}_{\mathrm{COM}}=1 \mathrm{~V} \text { to } 4.5 \mathrm{~V}, \end{aligned}$ | Switch OFF, See Figure 20 | $25^{\circ} \mathrm{C}$ | 5.5 V | -20 | $5 \quad 20$ | nA |
|  |  |  |  | Full |  | -150 | 150 |  |
|  | $\mathrm{I}_{\text {NO(PWROFF) }}$ | $\mathrm{V}_{\mathrm{NO}}=0$ to 5.5 V , <br> $\mathrm{V}_{\text {Сом }}=5.5 \mathrm{~V}$ to 0 , | Switch OFF, <br> See Figure 20 | $25^{\circ} \mathrm{C}$ | 0 V | -1 | $0.8 \quad 1$ | $\mu \mathrm{A}$ |
|  |  |  |  | Full |  | -25 | 25 |  |
| NO ON leakage current | $\mathrm{I}_{\mathrm{NO}(\mathrm{ON})}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{NO}}=1 \mathrm{~V} \text { or } 4.5 \mathrm{~V}, \\ & \mathrm{~V}_{\mathrm{COM}}=\text { Open, } \end{aligned}$ | Switch ON, See Figure 20 | $25^{\circ} \mathrm{C}$ | 5.5 V | -30 | 530 | nA |
|  |  |  |  | Full |  | -220 | 220 |  |
| COM OFF leakage current |  | $\begin{aligned} & \mathrm{V}_{\mathrm{NO}}=4.5 \mathrm{~V} \text { or } 1 \mathrm{~V}, \\ & \mathrm{~V}_{\mathrm{COM}}=1 \mathrm{~V} \text { or } 4.5 \mathrm{~V}, \end{aligned}$ | Switch OFF, See Figure 20 | $25^{\circ} \mathrm{C}$ | 5.5 V | -25 | $8 \quad 25$ | nA |
|  |  |  |  | Full |  | -250 | 250 |  |
|  | $I_{\text {Com(PWROFF) }}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{COM}}=0 \text { to } 5.5 \mathrm{~V}, \\ & \mathrm{~V}_{\mathrm{NO}}=5.5 \mathrm{~V} \text { to } 0, \end{aligned}$ | Switch OFF, <br> See Figure 20 | $25^{\circ} \mathrm{C}$ | 0 V | -8 | 0.18 | $\mu \mathrm{A}$ |
|  |  |  |  | Full |  | -50 | 50 |  |
| COM <br> ON leakage current | $\mathrm{I}_{\text {COM(ON }}$ | $\begin{array}{ll}\mathrm{V}_{\mathrm{NO}}=\text { Open, } \\ \mathrm{V}_{\mathrm{COM}}=1 \mathrm{~V} \text { or } 4.5 \mathrm{~V}, & \text { Switch ON, } \\ \text { See Figure }\end{array}$ |  | $25^{\circ} \mathrm{C}$ | 5.5 V | -30 | 530 | nA |
|  |  |  |  | Full |  | -220 | 220 |  |
| Digital Control Inputs (IN1, IN2) ${ }^{(2)}$ |  |  |  |  |  |  |  |  |
| Input logic high | $\mathrm{V}_{\mathrm{IH}}$ |  |  | Full |  | 2.4 | 5.5 | V |
| Input logic low | $\mathrm{V}_{\mathrm{IL}}$ |  |  | Full |  | 0 | 0.8 | V |
| Input leakage current | $\mathrm{I}_{\mathrm{IH}}, \mathrm{I}_{\text {IL }}$ | $\mathrm{V}_{1}=5.5 \mathrm{~V}$ or 0 |  | $25^{\circ} \mathrm{C}$ | 5.5 V | -2 | 2 | $\mu \mathrm{A}$ |
|  |  |  |  | Full |  | -20 | 20 |  |

(1) The algebraic convention, whereby the most negative value is a minimum and the most positive value is a maximum
(2) All unused digital inputs of the device must be held at $\mathrm{V}_{+}$or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.
$1-\Omega$ SP3T ANALOG SWITCH
5-V/3.3-V SINGLE-CHANNEL 3:1 MULTIPLEXER/DEMULTIPLEXER
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## ELECTRICAL CHARACTERISTICS FOR 5-V SUPPLY (continued)

$\mathrm{V}_{+}=4.5 \mathrm{~V}$ to $5.5 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$ (unless otherwise noted)


## ELECTRICAL CHARACTERISTICS FOR 3.3-V SUPPLY ${ }^{(1)}$

$\mathrm{V}_{+}=3 \mathrm{~V}$ to $3.6 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$ (unless otherwise noted)

| PARAMETER | SYMBOL | TEST CONDITIONS |  | TA | $\mathrm{V}_{+}$ | MIN | TYP | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Analog Switch |  |  |  |  |  |  |  |  |  |
| Analog signal range | $\mathrm{V}_{\text {COM }}, \mathrm{V}_{\text {NO }}$ |  |  |  |  | 0 |  | $\mathrm{V}_{+}$ | V |
| Peak ON resistance | $\mathrm{r}_{\text {peak }}$ | $\begin{aligned} & 0 \leq\left(\mathrm{V}_{\mathrm{NO}}\right) \leq \mathrm{V}_{+}, \\ & \mathrm{I}_{\mathrm{COM}}=-100 \mathrm{~mA}, \end{aligned}$ | Switch ON, See Figure 19 | $25^{\circ} \mathrm{C}$ | 3 V |  | 1.3 | 1.6 | $\Omega$ |
|  |  |  |  | Full |  |  |  | 2 |  |
| ON-state resistance | $\mathrm{r}_{\text {on }}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{NO}}=2 \mathrm{~V}, \\ & \mathrm{I}_{\mathrm{COM}}=-100 \mathrm{~mA}, \end{aligned}$ | Switch ON, See Figure 19 | $25^{\circ} \mathrm{C}$ | 3 V |  | 1.2 | 1.6 | $\Omega$ |
|  |  |  |  | Full |  |  |  | 1.8 |  |
| ON-state resistance match between channels | $\Delta r_{\text {on }}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{NO}}=2 \mathrm{~V}, 0.8 \mathrm{~V}, \\ & \mathrm{I}_{\mathrm{COM}}=-100 \mathrm{~mA}, \end{aligned}$ | Switch ON, See Figure 19 | $25^{\circ} \mathrm{C}$ | 3 V |  | 0.1 | 0.15 | $\Omega$ |
|  |  |  |  | Full |  |  |  | 0.15 |  |
| ON-state resistance flatness | $\mathrm{r}_{\text {onflat) }}$ | $\begin{aligned} & 0 \leq\left(\mathrm{V}_{\mathrm{NO}}\right) \leq \mathrm{V}_{+}, \\ & \mathrm{I}_{\mathrm{COM}}=-100 \mathrm{~mA}, \end{aligned}$ | Switch ON, <br> See Figure 19 | $25^{\circ} \mathrm{C}$ | 3 V |  | 0.2 |  | $\Omega$ |
|  |  | $\begin{aligned} & \mathrm{V}_{\mathrm{NO}}=2 \mathrm{~V}, 0.8 \mathrm{~V}, \\ & \mathrm{I}_{\mathrm{COM}}=-100 \mathrm{~mA}, \end{aligned}$ | Switch ON, See Figure 19 | $25^{\circ} \mathrm{C}$ |  |  | 0.2 | 0.35 |  |
|  |  |  |  | Full |  |  |  | 0.35 |  |
| NO OFF leakage current | $\mathrm{I}_{\text {NO(OFF) }}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{NO}}=1 \mathrm{~V} \text { or } 3 \mathrm{~V}, \\ & \mathrm{~V}_{\mathrm{COM}}=1 \mathrm{~V} \text { to } 3 \mathrm{~V}, \end{aligned}$ | Switch OFF, <br> See Figure 20 | $25^{\circ} \mathrm{C}$ | 3.6 V | -15 | 3 | 15 | nA |
|  |  |  |  | Full |  | -30 |  | 30 |  |
|  | $I_{\text {No(PWROFF) }}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{NO}}=0 \text { to } 3.6 \mathrm{~V}, \\ & \mathrm{~V}_{\mathrm{COM}}=3.6 \mathrm{~V} \text { to } 0, \end{aligned}$ | Switch OFF, <br> See Figure 20 | $25^{\circ} \mathrm{C}$ | 0 V | -1 | 0.2 | 1 | $\mu \mathrm{A}$ |
|  |  |  |  | Full |  | -10 |  | 10 |  |
| NO ON leakage current | $\mathrm{I}_{\mathrm{NO}(\mathrm{ON})}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{NO}}=1 \mathrm{~V} \text { or } 3 \mathrm{~V}, \\ & \mathrm{~V}_{\mathrm{COM}}=\text { Open, }, \end{aligned}$ | Switch ON, See Figure 20 | $25^{\circ} \mathrm{C}$ | 3.6 V | -15 | 3 | 15 | nA |
|  |  |  |  | Full |  | -40 |  | 40 |  |
| COM OFF leakage current | $\mathrm{I}_{\text {Com(OFF) }}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{NO}}=0 \mathrm{~V} \text { to } 3.6 \mathrm{~V}, \\ & \mathrm{~V}_{\mathrm{COM}}=1 \mathrm{~V} \text { or } \\ & \mathrm{V}_{\mathrm{NO}}=3.6 \mathrm{~V} \text { to } 0, \\ & \mathrm{~V}_{\mathrm{COM}}=3 \mathrm{~V}, \end{aligned}$ | Switch OFF, <br> See Figure 20 | $25^{\circ} \mathrm{C}$ | 3.6 V | -15 | 3 | 15 | nA |
|  |  |  |  | Full |  | -75 |  | 75 |  |
|  | $I_{\text {com(PWROFF) }}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{COM}}=0 \text { to } 3.6 \mathrm{~V}, \\ & \mathrm{~V}_{\mathrm{NO}}=3.6 \mathrm{~V} \text { to } 0, \end{aligned}$ | Switch OFF, <br> See Figure 20 | $25^{\circ} \mathrm{C}$ | 0 V | -1 | 0.2 | 1 | $\mu \mathrm{A}$ |
|  |  |  |  | Full |  | -20 |  | 20 |  |
| COM ON leakage current | $\mathrm{I}_{\text {com(ON }}$ | $\mathrm{V}_{\mathrm{NO}}=$ Open,$\mathrm{V}_{\text {COM }}=1 \mathrm{~V} \text { or } 3 \mathrm{~V} \text {, }$ | Switch ON, See Figure 20 | $25^{\circ} \mathrm{C}$ | 3.6 V | -15 | 4 | 15 | nA |
|  |  |  |  | Full |  | -40 |  | 40 |  |
| Digital Control Inputs (IN1, IN2) ${ }^{(2)}$ |  |  |  |  |  |  |  |  |  |
| Input logic high | $\mathrm{V}_{\mathrm{IH}}$ |  |  | Full |  | 2 |  | 5.5 | V |
| Input logic low | $\mathrm{V}_{\mathrm{IL}}$ |  |  | Full |  | 0 |  | 0.8 | V |
| Input leakage current | $I_{\text {IH }}, I_{\text {IL }}$ | $\mathrm{V}_{1}=5.5 \mathrm{~V}$ or 0 |  | $25^{\circ} \mathrm{C}$ | 3.6 V | -2 |  | 2 | nA |
|  |  |  |  | Full |  | -20 |  | 20 |  |

(1) The algebraic convention, whereby the most negative value is a minimum and the most positive value is a maximum
(2) All unused digital inputs of the device must be held at $\mathrm{V}_{+}$or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.
$1-\Omega$ SP3T ANALOG SWITCH
5-V/3.3-V SINGLE-CHANNEL 3:1 MULTIPLEXER/DEMULTIPLEXER
SCDS214C-OCTOBER 2005-REVISED JANUARY 2008
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## ELECTRICAL CHARACTERISTICS FOR 3.3-V SUPPLY (continued)

$\mathrm{V}_{+}=3 \mathrm{~V}$ to $3.6 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$ (unless otherwise noted)

| PARAMETER | SYMBOL | TEST CONDITIONS |  | TA | $\mathrm{V}_{+}$ | MIN | TYP | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Dynamic |  |  |  |  |  |  |  |  |  |
| Turn-on time | ton | $\begin{aligned} & \mathrm{V}_{\mathrm{COM}}=\mathrm{V}_{+}, \\ & \mathrm{R}_{\mathrm{L}}=50 \Omega, \end{aligned}$ | $\begin{aligned} & C_{\mathrm{L}}=35 \mathrm{pF}, \\ & \text { See Figure } 23 \end{aligned}$ | $25^{\circ} \mathrm{C}$ | 3.3 V | 1 | 16 | 30.5 | ns |
|  |  |  |  | Full | 3 V to 3.6 V | 1 |  | 34 |  |
| Turn-off time | $\mathrm{t}_{\text {OFF }}$ | $\begin{aligned} & \mathrm{V}_{\text {Сом }}=\mathrm{V}_{+}, \\ & \mathrm{R}_{\mathrm{L}}=50 \Omega, \end{aligned}$ | $\begin{aligned} & \mathrm{C}_{\mathrm{L}}=35 \mathrm{pF}, \\ & \text { See Figure } 23 \end{aligned}$ | $25^{\circ} \mathrm{C}$ | 3.3 V | 1 | 6 | 11.5 | ns |
|  |  |  |  | Full | 3 V to 3.6 V | 1 |  | 12.5 |  |
| Break-beforemake time | $t_{\text {BBM }}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{NO}}=\mathrm{V}_{+}, \\ & \mathrm{R}_{\mathrm{L}}=50 \Omega, \end{aligned}$ | $\begin{aligned} & \mathrm{C}_{\mathrm{L}}=35 \mathrm{pF}, \\ & \text { See Figure } 24 \end{aligned}$ | $25^{\circ} \mathrm{C}$ | 3.3 V | 0.5 | 13 | 26 | ns |
|  |  |  |  | Full | 3 V to 3.6 V | 0.5 |  | 30 |  |
| Charge injection | $Q_{C}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{GEN}}=0, \\ & \mathrm{R}_{\mathrm{GEN}}=0, \end{aligned}$ | $\begin{aligned} & \mathrm{C}_{\mathrm{L}}=1 \mathrm{nF}, \\ & \text { See Figure 28 } \end{aligned}$ | $25^{\circ} \mathrm{C}$ | 3.3 V |  | 12 |  | pC |
| NO OFF capacitance | $\mathrm{C}_{\text {NO(OFF) }}$ | $\mathrm{V}_{\mathrm{NO}}=\mathrm{V}_{+} \text {or } \mathrm{GND} \text {, }$ <br> Switch OFF, | See Figure 22 | $25^{\circ} \mathrm{C}$ | 3.3 V |  | 18 |  | pF |
| COM OFF capacitance | $\mathrm{C}_{\text {COM (OFF) }}$ | $\mathrm{V}_{\text {Сом }}=\mathrm{V}_{+}$or GND, Switch OFF, | See Figure 22 | $25^{\circ} \mathrm{C}$ | 3.3 V |  | 55 |  | pF |
| NO <br> ON capacitance | $\mathrm{C}_{\mathrm{NO}(\mathrm{ON})}$ | $\mathrm{V}_{\mathrm{NO}}=\mathrm{V}_{+} \text {or } \mathrm{GND} \text {, }$ <br> Switch ON, | See Figure 22 | $25^{\circ} \mathrm{C}$ | 3.3 V |  | 78 |  | pF |
| COM ON capacitance | $\mathrm{C}_{\text {COM(ON) }}$ | $\mathrm{V}_{\text {COM }}=\mathrm{V}_{+}$or GND, Switch ON, | See Figure 22 | $25^{\circ} \mathrm{C}$ | 3.3 V |  | 78 |  | pF |
| Digital input capacitance | $\mathrm{C}_{1}$ | $\mathrm{V}_{1}=\mathrm{V}_{+}$or GND, | See Figure 22 | $25^{\circ} \mathrm{C}$ | 3.3 V |  | 2.5 |  | pF |
| Bandwidth | BW | $\begin{aligned} & \mathrm{R}_{\mathrm{L}}=50 \Omega, \\ & \text { Switch ON, } \end{aligned}$ | See Figure 25 | $25^{\circ} \mathrm{C}$ | 3.3 V |  | 73 |  | MHz |
| OFF isolation | OISO | $\begin{aligned} & R_{L}=50 \Omega, \\ & f=1 \mathrm{MHz}, \end{aligned}$ | Switch OFF, <br> See Figure 26 | $25^{\circ} \mathrm{C}$ | 3.3 V |  | -64 |  | dB |
| Crosstalk | $\mathrm{X}_{\text {TALK }}$ | $\begin{aligned} & R_{\mathrm{L}}=50 \Omega, \\ & \mathrm{f}=1 \mathrm{MHz}, \end{aligned}$ | Switch ON, See Figure 27 | $25^{\circ} \mathrm{C}$ | 3.3 V |  | -64 |  | dB |
| Total harmonic distortion | THD | $\begin{aligned} & \mathrm{R}_{\mathrm{L}}=600 \Omega, \\ & \mathrm{C}_{\mathrm{L}}=50 \mathrm{pF}, \end{aligned}$ | $\begin{aligned} & \mathrm{f}=20 \mathrm{~Hz} \text { to } 20 \mathrm{kHz}, \\ & \text { See Figure } 29 \end{aligned}$ | $25^{\circ} \mathrm{C}$ | 3.3 V |  | 0.010 |  | \% |
| Supply |  |  |  |  |  |  |  |  |  |
| Positive supply current | $I_{+}$ | $\mathrm{V}_{\mathrm{I}}=\mathrm{V}_{+}$or GND, | Switch ON or OFF | $25^{\circ} \mathrm{C}$ Full | 3.6 V |  | 2 | 20 | nA |

## ELECTRICAL CHARACTERISTICS FOR 2.5-V SUPPLY ${ }^{(1)}$

$\mathrm{V}_{+}=2.3 \mathrm{~V}$ to $2.7 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$ (unless otherwise noted)

| PARAMETER | SYMBOL | TEST CONDITIONS |  | TA | $\mathrm{V}_{+}$ | MIN | TYP | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Analog Switch |  |  |  |  |  |  |  |  |  |
| Analog signal range | $\mathrm{V}_{\text {COM }}, \mathrm{V}_{\text {No }}$ |  |  |  |  | 0 |  | $\mathrm{V}_{+}$ | V |
| Peak ON resistance | $\mathrm{r}_{\text {peak }}$ | $\begin{aligned} & 0 \leq\left(V_{\mathrm{NO}}\right) \leq \mathrm{V}_{+}, \\ & \mathrm{I}_{\text {COM }}=-8 \mathrm{~mA}, \end{aligned}$ | Switch ON, See Figure 19 | $25^{\circ} \mathrm{C}$ | 2.3 V |  | 1.8 | 2.5 | $\Omega$ |
|  |  |  |  | Full |  |  |  | 2.7 |  |
| ON-state resistance | $r_{\text {on }}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{NO}}=1.8 \mathrm{~V}, \\ & \mathrm{I}_{\mathrm{COM}}=-8 \mathrm{~mA}, \end{aligned}$ | Switch ON, See Figure 19 | $25^{\circ} \mathrm{C}$ | 2.3 V |  | 1.5 | 2 | $\Omega$ |
|  |  |  |  | Full |  |  |  | 2.4 |  |
| ON-state resistance match between channels | $\Delta r_{\text {on }}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{NO}}=1.8 \mathrm{~V}, \\ & \mathrm{I}_{\mathrm{COM}}=-8 \mathrm{~mA}, \end{aligned}$ | $\begin{aligned} & \text { Switch ON, } \\ & \text { See Figure } 19 \end{aligned}$ | $25^{\circ} \mathrm{C}$ | 2.3 V |  |  | 0.2 | $\Omega$ |
|  |  |  |  | Full |  |  |  | 0.2 |  |
| ON-state resistance flatness | $\mathrm{r}_{\text {onflat) }}$ | $\begin{aligned} & 0 \leq\left(V_{\mathrm{NO}}\right) \leq \mathrm{V}_{+}, \\ & \mathrm{I}_{\text {COM }}=-8 \mathrm{~mA}, \end{aligned}$ | Switch ON, See Figure 19 | $25^{\circ} \mathrm{C}$ | 2.3 V | 0.6 |  |  | $\Omega$ |
|  |  | $\begin{aligned} & \mathrm{V}_{\mathrm{NO}}=0.8 \mathrm{~V}, 1.8 \mathrm{~V} \\ & \mathrm{I}_{\mathrm{COM}}=-8 \mathrm{~mA}, \end{aligned}$ | Switch ON, <br> See Figure 19 | $25^{\circ} \mathrm{C}$ |  |  | 0.6 | 1 |  |
|  |  |  |  | Full |  |  |  | 1 |  |
| NO OFF leakage current | $\mathrm{I}_{\mathrm{NO} \text { (OFF) }}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{NO}}=0.5 \mathrm{~V} \text { or } 2.3 \mathrm{~V}, \\ & \mathrm{~V}_{\mathrm{COM}}=0.5 \mathrm{~V} \text { to } 2.3 \mathrm{~V}, \end{aligned}$ | Switch OFF, <br> See Figure 20 | $25^{\circ} \mathrm{C}$ | 2.7 V | -15 | 3 | 15 | nA |
|  |  |  |  | Full |  | -30 |  | 30 |  |
|  | $I_{\text {No(PWROFF) }}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{NO}}=0 \text { to } 2.7 \mathrm{~V}, \\ & \mathrm{~V}_{\mathrm{COM}}=2.7 \mathrm{~V} \text { to } 0, \end{aligned}$ | Switch OFF, <br> See Figure 20 | $25^{\circ} \mathrm{C}$ | 0 V | -1 | 0.1 | 1 | $\mu \mathrm{A}$ |
|  |  |  |  | Full |  | -10 |  | 10 |  |
| NO ON leakage current | $\mathrm{I}_{\mathrm{NO}(\mathrm{ON})}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{NO}}=0.5 \mathrm{~V} \text { or } 2.3 \mathrm{~V}, \\ & \mathrm{~V}_{\mathrm{COM}}=\text { Open, } \end{aligned}$ | Switch ON, See Figure 20 | $25^{\circ} \mathrm{C}$ | 2.7 V | -15 | 3 | 15 | nA |
|  |  |  |  | Full |  | -35 |  | 35 |  |
| COM OFF leakage current | $\mathrm{I}_{\text {com( }}^{\text {(OFF) }}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{NO}}=0.3 \mathrm{~V} \text { to } 2.3 \mathrm{~V}, \\ & \mathrm{~V}_{\mathrm{COM}}=0.5 \mathrm{~V} \text { or } 2.3 \mathrm{~V}, \end{aligned}$ | Switch OFF, <br> See Figure 20 | $25^{\circ} \mathrm{C}$ | 2.7 V | -15 | 3 | 15 | nA |
|  |  |  |  | Full |  | -60 |  | 60 |  |
|  | ICom(PWROFF) | $\begin{aligned} & \mathrm{V}_{\mathrm{COM}}=0 \text { to } 2.7 \mathrm{~V}, \\ & \mathrm{~V}_{\mathrm{NO}}=2.7 \mathrm{~V} \text { to } 0, \end{aligned}$ | Switch OFF, <br> See Figure 20 | $25^{\circ} \mathrm{C}$ | 0 V | -1 | 0.1 | 1 | $\mu \mathrm{A}$ |
|  |  |  |  | Full |  | -10 |  | 10 |  |
| COM ON leakage current | $\mathrm{I}_{\text {COM (ON }}$ | $\begin{array}{ll}\mathrm{V}_{\mathrm{NO}}=\text { Open, } \\ \mathrm{V}_{\mathrm{COM}}=0.5 \mathrm{~V} \text { or 2.2 V, } & \text { Switch ON, } \\ \text { See Figure } 20\end{array}$ |  | $25^{\circ} \mathrm{C}$ | 2.7 V | -15 | 3.5 | 15 | nA |
|  |  |  |  | Full |  | -40 |  | 40 |  |
| Digital Control Inputs (IN1, IN2) ${ }^{(2)}$ |  |  |  |  |  |  |  |  |  |
| Input logic high | $\mathrm{V}_{\mathrm{IH}}$ |  |  | Full |  | 1.8 |  | 5.5 | V |
| Input logic low | $\mathrm{V}_{\text {IL }}$ |  |  | Full |  | 0 |  | 0.6 | V |
| Input leakage current | $\mathrm{I}_{\mathrm{H}}, \mathrm{I}_{\text {IL }}$ | $\mathrm{V}_{1}=5.5 \mathrm{~V}$ or 0 |  | $25^{\circ} \mathrm{C}$ | 2.7 V | 1 |  | 1 | nA |
|  |  |  |  | Full |  | 10 |  | 10 |  |

(1) The algebraic convention, whereby the most negative value is a minimum and the most positive value is a maximum
(2) All unused digital inputs of the device must be held at $\mathrm{V}_{+}$or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.

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5-V/3.3-V SINGLE-CHANNEL 3:1 MULTIPLEXER/DEMULTIPLEXER
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INSTRUMENTS

## ELECTRICAL CHARACTERISTICS FOR 2.5-V SUPPLY (continued)

$\mathrm{V}_{+}=2.3 \mathrm{~V}$ to $2.7 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$ (unless otherwise noted)

| PARAMETER | SYMBOL | TEST CONDITIONS |  | $\mathrm{T}_{\text {A }}$ | $\mathrm{V}_{+}$ | MIN | TYP | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Dynamic |  |  |  |  |  |  |  |  |  |
| Turn-on time | ton | $\begin{aligned} & \mathrm{V}_{\mathrm{COM}}=\mathrm{V}_{+}, \\ & \mathrm{R}_{\mathrm{L}}=50 \Omega, \end{aligned}$ | $\begin{aligned} & \mathrm{C}_{\mathrm{L}}=35 \mathrm{pF}, \\ & \text { See Figure } 23 \end{aligned}$ | $25^{\circ} \mathrm{C}$ | 2.5 V | 2 | 4.5 | 43 | ns |
|  |  |  |  | Full | 2.3 V to 2.7 V | 2 |  | 47.5 |  |
| Turn-off time | toff | $\begin{aligned} & \mathrm{V}_{\text {Сом }}=\mathrm{V}_{+}, \\ & \mathrm{R}_{\mathrm{L}}=50 \Omega, \end{aligned}$ | $\begin{aligned} & \mathrm{C}_{\mathrm{L}}=35 \mathrm{pF}, \\ & \text { See Figure } 23 \end{aligned}$ | $25^{\circ} \mathrm{C}$ | 2.5 V | 2 | 8.5 | 11 | ns |
|  |  |  |  | Full | 2.3 V to 2.7 V | 2 |  | 12.5 |  |
| Break-beforemake time | $\mathrm{t}_{\text {BBM }}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{NO}}=\mathrm{V}_{+}, \\ & \mathrm{R}_{\mathrm{L}}=50 \Omega, \end{aligned}$ | $\begin{aligned} & C_{L}=35 \mathrm{pF}, \\ & \text { See Figure } 24 \end{aligned}$ | $25^{\circ} \mathrm{C}$ | 2.5 V | 0.5 | 18.5 | 38.5 | ns |
|  |  |  |  | Full | 2.3 V to 2.7 V | 0.5 |  | 43 |  |
| Charge injection | $Q_{C}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{GEN}}=0, \\ & \mathrm{R}_{\mathrm{GEN}}=0, \end{aligned}$ | $\begin{aligned} & \mathrm{C}_{\mathrm{L}}=1 \mathrm{nF}, \\ & \text { See Figure } 28 \end{aligned}$ | $25^{\circ} \mathrm{C}$ | 2.5 V |  | 8 |  | pC |
| NO OFF capacitance | $\mathrm{C}_{\text {NO(OFF) }}$ | $\mathrm{V}_{\mathrm{NO}}=\mathrm{V}_{+}$or GND, Switch OFF, | See Figure 22 | $25^{\circ} \mathrm{C}$ | 2.5 V |  | 18.5 |  | pF |
| COM OFF capacitance | $\mathrm{C}_{\text {COM (OFF) }}$ | $\mathrm{V}_{\text {Сом }}=\mathrm{V}_{+}$or GND, Switch OFF, | See Figure 22 | $25^{\circ} \mathrm{C}$ | 2.5 V |  | 55 |  | pF |
| NO ON capacitance | $\mathrm{C}_{\mathrm{NO}(\mathrm{ON})}$ | $\mathrm{V}_{\mathrm{NO}}=\mathrm{V}_{+}$or GND, Switch ON, | See Figure 22 | $25^{\circ} \mathrm{C}$ | 2.5 V |  | 78 |  | pF |
| COM <br> ON capacitance | $\mathrm{C}_{\text {COM(ON) }}$ | $\mathrm{V}_{\text {Сом }}=\mathrm{V}_{+}$or GND, Switch ON, | See Figure 22 | $25^{\circ} \mathrm{C}$ | 2.5 V |  | 78 |  | pF |
| Digital input capacitance | $\mathrm{C}_{1}$ | $\mathrm{V}_{1}=\mathrm{V}_{+}$or GND, | See Figure 22 | $25^{\circ} \mathrm{C}$ | 2.5 V |  | 3 |  | pF |
| Bandwidth | BW | $\begin{aligned} & \mathrm{R}_{\mathrm{L}}=50 \Omega, \\ & \text { Switch ON, } \end{aligned}$ | See Figure 25 | $25^{\circ} \mathrm{C}$ | 2.5 V |  | 73 |  | MHz |
| OFF isolation | $\mathrm{O}_{\text {ISO }}$ | $\begin{aligned} & \mathrm{R}_{\mathrm{L}}=50 \Omega, \\ & \mathrm{f}=1 \mathrm{MHz}, \end{aligned}$ | Switch OFF, <br> See Figure 26 | $25^{\circ} \mathrm{C}$ | 2.5 V |  | -64 |  | dB |
| Crosstalk | $\mathrm{X}_{\text {taLK }}$ | $\begin{aligned} & \mathrm{R}_{\mathrm{L}}=50 \Omega, \\ & \mathrm{f}=1 \mathrm{MHz}, \end{aligned}$ | Switch ON, <br> See Figure 27 | $25^{\circ} \mathrm{C}$ | 2.5 V |  | -64 |  | dB |
| Total harmonic distortion | THD | $\begin{aligned} & \mathrm{R}_{\mathrm{L}}=600 \Omega, \\ & \mathrm{C}_{\mathrm{L}}=50 \mathrm{pF}, \end{aligned}$ | $\begin{aligned} & \mathrm{f}=20 \mathrm{~Hz} \text { to } 20 \mathrm{kHz}, \\ & \text { See Figure } 29 \end{aligned}$ | $25^{\circ} \mathrm{C}$ | 2.5 V |  | 0.030 |  | \% |
| Supply |  |  |  |  |  |  |  |  |  |
| Positive supply current | $I_{+}$ | $\mathrm{V}_{1}=\mathrm{V}_{+}$or GND, | Switch ON or OFF | $25^{\circ} \mathrm{C}$ | 2.7 V |  | 1 | 10 | nA |
|  |  |  |  | Full |  |  |  | 250 |  |

## ELECTRICAL CHARACTERISTICS FOR 1.8-V SUPPLY ${ }^{(1)}$

$\mathrm{V}_{+}=1.65 \mathrm{~V}$ to $1.95 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$ (unless otherwise noted)

| PARAMETER | SYMBOL | TEST CONDITIONS |  | TA | $\mathrm{V}_{+}$ | MIN | TYP | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Analog Switch |  |  |  |  |  |  |  |  |  |
| Analog signal range | $\mathrm{V}_{\text {COM }}, \mathrm{V}_{\text {NO }}$ |  |  |  |  | 0 |  | $V_{+}$ | V |
| Peak ON resistance | $\mathrm{r}_{\text {peak }}$ | $\begin{aligned} & 0 \leq\left(V_{\mathrm{NO}}\right) \leq \mathrm{V}_{+}, \\ & \mathrm{I}_{\mathrm{COM}}=-2 \mathrm{~mA}, \end{aligned}$ | Switch ON, <br> See Figure 19 | $25^{\circ} \mathrm{C}$ | 1.65 V | 5 |  |  | $\Omega$ |
|  |  |  |  | Full |  |  |  | 30 |  |
| ON-state resistance | $r_{\text {on }}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{NO}}=1.5 \mathrm{~V}, \\ & \mathrm{I}_{\mathrm{COM}}=-2 \mathrm{~mA}, \end{aligned}$ | Switch ON, See Figure 19 | $25^{\circ} \mathrm{C}$ | 1.65 V |  | 2 | 2.5 | $\Omega$ |
|  |  |  |  | Full |  |  |  | 3.5 |  |
| ON-state resistance match between channels | $\Delta r_{\text {on }}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{NO}}=1.5 \mathrm{~V}, \\ & \mathrm{I}_{\mathrm{COM}}=-2 \mathrm{~mA}, \end{aligned}$ | Switch ON, See Figure 19 | $25^{\circ} \mathrm{C}$ | 1.65 V |  | 0.15 | 0.4 | $\Omega$ |
|  |  |  |  | Full |  |  |  | 0.4 |  |
| ON-state resistance flatness | $\mathrm{r}_{\text {on(flat) }}$ | $\begin{aligned} & 0 \leq\left(V_{\mathrm{NO}}\right) \leq \mathrm{V}_{+}, \\ & \mathrm{I}_{\text {COM }}=-2 \mathrm{~mA}, \end{aligned}$ | Switch ON, See Figure 19 | $25^{\circ} \mathrm{C}$ | 1.65 V | 5 |  |  | $\Omega$ |
|  |  | $\begin{aligned} & \mathrm{V}_{\mathrm{NO}}=0.6 \mathrm{~V}, 1.5 \mathrm{~V} \\ & \mathrm{I}_{\mathrm{COM}}=-2 \mathrm{~mA}, \end{aligned}$ | Switch ON, See Figure 19 | $25^{\circ} \mathrm{C}$ |  |  | 4.5 |  |  |
|  |  |  |  | Full |  |  | 5 |  |  |
| NO OFF leakage current | $\mathrm{I}_{\mathrm{NO} \text { (OFF) }}$ | $\mathrm{V}_{\mathrm{NO}}=0.3 \mathrm{~V}$ or 1.65 V , <br> $\mathrm{V}_{\text {COM }}=0.3 \mathrm{~V}$ to 1.65 V , | Switch OFF See Figure 20 | $25^{\circ} \mathrm{C}$ | 1.95 V | -15 | 3 | 15 | nA |
|  |  |  |  | Full |  | -30 |  | 30 |  |
|  | $I_{\text {INO(PWROFF) }}$ | $\mathrm{V}_{\mathrm{NO}}=0$ to 1.95 V , <br> $\mathrm{V}_{\text {Сом }}=1.95 \mathrm{~V}$ to 0 , | Switch OFF, <br> See Figure 20 | $25^{\circ} \mathrm{C}$ | 0 V | -1 | 0.1 | 1 | $\mu \mathrm{A}$ |
|  |  |  |  | Full |  | -15 |  | 15 |  |
| NO ON leakage current | $\mathrm{I}_{\mathrm{NO}(\mathrm{ON})}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{NO}}=0.3 \mathrm{~V} \text { or } 1.65 \mathrm{~V}, \\ & \mathrm{~V}_{\mathrm{COM}}=\text { Open, } \end{aligned}$ | Switch ON, <br> See Figure 20 | $25^{\circ} \mathrm{C}$ | 1.95 V | -15 | 3 | 15 | nA |
|  |  |  |  | Full |  | -30 |  | 30 |  |
| COM OFF leakage current | ICom(OFF) | $\mathrm{V}_{\mathrm{NO}}=0.3 \mathrm{~V}$ to 1.65 V , <br> $\mathrm{V}_{\text {Сом }}=0.3 \mathrm{~V}$ or 1.65 V , | Switch OFF, <br> See Figure 20 | $25^{\circ} \mathrm{C}$ | 1.95 V | -15 | 3 | 15 | nA |
|  |  |  |  | Full |  | -50 |  | 50 |  |
|  | ICOM(PWROF F) | $\begin{aligned} & \mathrm{V}_{\mathrm{COM}}=0 \text { to } 1.95 \mathrm{~V}, \\ & \mathrm{~V}_{\mathrm{NO}}=1.95 \mathrm{~V} \text { to } 0, \end{aligned}$ | Switch OFF, See Figure 20 | $25^{\circ} \mathrm{C}$ | 0 V | -1 | 0.1 | 1 | $\mu \mathrm{A}$ |
|  |  |  |  | Full |  | -10 |  | 10 |  |
| COM ON leakage current | $\mathrm{I}_{\text {COM(ON })}$ | $\mathrm{V}_{\mathrm{NO}}=\mathrm{Or}$ <br> $\mathrm{V}_{\mathrm{COM}}=$ <br> N2) ${ }^{(2)}$ | Switch ON, See Figure 20 | $25^{\circ} \mathrm{C}$ | 1.95 V | -15 | 3 | 15 | nA |
|  |  |  |  | Full |  | -30 |  | 30 |  |
| Digital Control Inputs (IN1, IN2) ${ }^{(2)}$ |  |  |  |  |  |  |  |  |  |
| Input logic high | $\mathrm{V}_{\mathrm{IH}}$ |  |  |  | Full |  | 1.5 |  | 5.5 | V |
| Input logic low | $\mathrm{V}_{\mathrm{IL}}$ |  |  | Full |  | 0 |  | 0.6 | V |
| Input leakage current | $I_{\text {IH }}, \mathrm{I}_{\text {IL }}$ | $\mathrm{V}_{1}=5.5 \mathrm{~V}$ or 0 |  | $25^{\circ} \mathrm{C}$ | 1.95 V | -2 |  | 2 | nA |
|  |  |  |  | Full |  | -20 |  | 20 |  |

(1) The algebraic convention, whereby the most negative value is a minimum and the most positive value is a maximum
(2) All unused digital inputs of the device must be held at $\mathrm{V}_{+}$or GND to ensure proper device operation. Refer to the Tl application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.
$1-\Omega$ SP3T ANALOG SWITCH
5-V/3.3-V SINGLE-CHANNEL 3:1 MULTIPLEXER/DEMULTIPLEXER

## ELECTRICAL CHARACTERISTICS FOR 1.8-V SUPPLY (continued)

$\mathrm{V}_{+}=1.65 \mathrm{~V}$ to $1.95 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$ (unless otherwise noted)

| PARAMETER | SYMBOL | TEST CONDITIONS |  | TA | $\mathrm{V}_{+}$ | MIN | TYP | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Dynamic |  |  |  |  |  |  |  |  |  |
| Turn-on time | ton | $\begin{aligned} & V_{\text {com }}=V_{+}, \\ & R_{L}=50 \Omega, \end{aligned}$ | $\begin{aligned} & C_{L}=35 \mathrm{pF}, \\ & \text { See Figure } 23 \end{aligned}$ | $25^{\circ} \mathrm{C}$ | 1.8 V | 3 | 38.5 | 85 | ns |
|  |  |  |  | Full | 1.65 V to 1.95 V | 3 |  | 90 |  |
| Turn-off time | $\mathrm{t}_{\text {OFF }}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{COM}}=\mathrm{V}_{+}, \\ & \mathrm{R}_{\mathrm{L}}=50 \Omega, \end{aligned}$ | $\begin{aligned} & C_{\mathrm{L}}=35 \mathrm{pF}, \\ & \text { See Figure } 23 \end{aligned}$ | $25^{\circ} \mathrm{C}$ | 1.8 V | 2 | 8.5 | 16 | ns |
|  |  |  |  | Full | 1.65 V to 1.95 V | 2 |  | 18 |  |
| Break-beforemake time | $t_{\text {BBM }}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{NO}}=\mathrm{V}_{+}, \\ & \mathrm{R}_{\mathrm{L}}=50 \Omega, \end{aligned}$ | $\begin{aligned} & C_{\mathrm{L}}=35 \mathrm{pF}, \\ & \text { See Figure } 24 \end{aligned}$ | $25^{\circ} \mathrm{C}$ | 1.8 V | 1 | 33 | 75 | ns |
|  |  |  |  | Full | 1.65 V to 1.95 V | 1 |  | 80 |  |
| Charge injection | $\mathrm{Q}_{\mathrm{C}}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{GEN}}=0, \\ & \mathrm{R}_{\mathrm{GEN}}=0, \\ & \hline \end{aligned}$ | $\begin{aligned} & C_{L}=1 \mathrm{nF}, \\ & \text { See Figure } 28 \end{aligned}$ | $25^{\circ} \mathrm{C}$ | 1.8 V |  | 5 |  | pC |
| NO OFF capacitance | $\mathrm{C}_{\text {NO(OFF) }}$ | $\mathrm{V}_{\mathrm{NO}}=\mathrm{V}_{+}$or GND, Switch OFF, | See Figure 22 | $25^{\circ} \mathrm{C}$ | 1.8 V |  | 18.5 |  | pF |
| COM OFF capacitance | $\mathrm{C}_{\text {COM (OFF) }}$ | $\mathrm{V}_{\text {Сом }}=\mathrm{V}_{+}$or GND, Switch OFF, | See Figure 23 | $25^{\circ} \mathrm{C}$ | 1.8 V |  | 55 |  | pF |
| NO ON capacitance | $\mathrm{C}_{\mathrm{NO}(\mathrm{ON})}$ | $\mathrm{V}_{\mathrm{NO}}=\mathrm{V}_{+}$or GND, Switch ON, | See Figure 22 | $25^{\circ} \mathrm{C}$ | 1.8 V |  | 78 |  | pF |
| COM ON capacitance | $\mathrm{C}_{\text {COM(ON) }}$ | $\mathrm{V}_{\text {Сом }}=\mathrm{V}_{+}$or GND, Switch ON, | See Figure 22 | $25^{\circ} \mathrm{C}$ | 1.8 V |  | 78 |  | pF |
| Digital input capacitance | $\mathrm{C}_{1}$ | $\mathrm{V}_{1}=\mathrm{V}_{+}$or GND, | See Figure 22 | $25^{\circ} \mathrm{C}$ | 1.8 V |  | 3 |  | pF |
| Bandwidth | BW | $\begin{aligned} & \mathrm{R}_{\mathrm{L}}=50 \Omega, \\ & \text { Switch ON, } \end{aligned}$ | See Figure 25 | $25^{\circ} \mathrm{C}$ | 1.8 V |  | 73 |  | MHz |
| OFF isolation | $\mathrm{O}_{\text {ISO }}$ | $\begin{aligned} & R_{\mathrm{L}}=50 \Omega, \\ & \mathrm{f}=1 \mathrm{M} \mathrm{~Hz}, \end{aligned}$ | Switch OFF, See Figure 26 | $25^{\circ} \mathrm{C}$ | 1.8 V |  | -64 |  | dB |
| Crosstalk | $\mathrm{X}_{\text {taLK }}$ | $\begin{aligned} & \mathrm{R}_{\mathrm{L}}=50 \Omega, \\ & \mathrm{f}=1 \mathrm{MHz}, \end{aligned}$ | Switch ON, <br> See Figure 27 | $25^{\circ} \mathrm{C}$ | 1.8 V |  | -64 |  | dB |
| Total harmonic distortion | THD | $\begin{aligned} & \mathrm{R}_{\mathrm{L}}=600 \Omega, \\ & \mathrm{C}_{\mathrm{L}}=50 \mathrm{pF}, \end{aligned}$ | $\begin{aligned} & \mathrm{f}=20 \mathrm{~Hz} \text { to } 20 \mathrm{kHz}, \\ & \text { See Figure } 29 \end{aligned}$ | $25^{\circ} \mathrm{C}$ | 1.8 V |  | 0.080 |  | \% |
| Supply |  |  |  |  |  |  |  |  |  |
| Positive supply current | $I_{+}$ | $\mathrm{V}_{1}=\mathrm{V}_{+}$or GND, | Switch ON or OFF | $25^{\circ} \mathrm{C}$ | 1.95 V |  | 1 |  | nA |
|  |  |  |  | Full |  |  |  | 200 |  |

TYPICAL PERFORMANCE


Figure 1. $r_{\text {on }}$ vs $\mathrm{V}_{\text {com }}$


Figure 3. $\mathrm{r}_{\text {on }}$ vs $\mathrm{V}_{\text {com }}\left(\mathrm{V}_{+}=5 \mathrm{~V}\right)$


Figure 5. Leakage Current vs Temperature


Figure 2. $\mathrm{r}_{\text {on }}$ vs $\mathrm{V}_{\mathrm{COM}}\left(\mathrm{V}_{+}=3.3 \mathrm{~V}\right)$


Figure 4. Leakage Current vs Temperature


Figure 6. Leakage Current vs Temperature

TYPICAL PERFORMANCE (continued)


Figure 7. Leakage Current vs Temperature


Figure 9. $\mathrm{t}_{\mathrm{ON}}$ and $\mathrm{t}_{\text {OFF }}$ vs Supply Voltage


Figure 11. Logic-Level Threshold vs $\mathrm{V}_{+}$


Figure 8. Charge Injection $\left(\mathrm{Q}_{\mathrm{C}}\right)$ vs $\mathrm{V}_{\text {com }}$


Figure 10. $\mathrm{t}_{\mathrm{ON}}$ and $\mathrm{t}_{\mathrm{OFF}}$ vs Temperature


Figure 12. Bandwidth ( $\mathrm{V}_{+}=5 \mathrm{~V}$ )

## TYPICAL PERFORMANCE (continued)



Figure 13. OFF Isolation vs Crosstalk


Figure 15. Power-Supply Current vs Temperature ( $\mathrm{V}_{+}=5$ )


Figure 17. COM Port to NOO PSRR,
$\mathrm{IN} 1=\mathrm{V}_{\mathrm{C}}, \mathrm{IN} 2=\mathrm{V}_{\mathrm{CC}}\left(\mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V}\right)$


Figure 14. Total Harmonic Distortion vs Frequency


Figure 16. COM Port to NO2 PSRR, $\mathrm{IN} 1=\mathrm{V}_{\mathrm{Cc}}, \mathrm{IN} 2=\mathrm{V}_{\mathrm{Cc}}\left(\mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V}\right)$


Figure 18. COM Port Hi-Z PSRR,
$\mathrm{IN} 1=0 \mathrm{~V}, \mathrm{IN} 2=0 \mathrm{~V}\left(\mathrm{~V}_{\mathrm{cc}}=5 \mathrm{~V}\right)$

## PIN DESCRIPTION

| PIN NO. | NAME | DESCRIPTION |
| :---: | :---: | :--- |
| 1 | NO0 | Normally open |
| 2 | NO1 | Normally open |
| 3 | NO2 | Normally open |
| 4 | GND | Digital ground |
| 5 | IN2 | Digital control to connect COM to NO |
| 6 | IN1 | Digital control to connect COM to NO |
| 7 | COM | Common |
| 8 | $\mathrm{~V}_{+}$ | Power supply |

## PARAMETER DESCRIPTION

| SYMBOL | DESCRIPTION |
| :---: | :---: |
| $\mathrm{V}_{\text {COM }}$ | Voltage at COM |
| $\mathrm{V}_{\mathrm{NO}}$ | Voltage at NO |
| $\mathrm{r}_{\text {on }}$ | Resistance between COM and NC or COM and NO ports when the channel is ON |
| $r_{\text {peak }}$ | Peak on-state resistance over a specified voltage range |
| $\Delta r_{\text {on }}$ | Difference of $r_{\text {on }}$ between channels in a specific device |
| $\mathrm{r}_{\text {on(flat }}$ | Difference between the maximum and minimum value of $\mathrm{r}_{\text {on }}$ in a channel over the specified range of conditions |
| $\mathrm{I}_{\text {NO(OFF) }}$ | Leakage current measured th the NO port, with the corresponding channel (NO to COM) in the OFF state |
| $\mathrm{I}_{\text {NO(PWROFF) }}$ | Leakage current measured at the NO port during the power-down condition, $\mathrm{V}_{+}=0$. |
| $\mathrm{I}_{\mathrm{NO}(\mathrm{ON})}$ | Leakage current measured at the NO port, with the corresponding channel (NO to COM) in the ON state and the output (COM) open |
| $\mathrm{I}_{\text {COM(ON }}$ | Leakage current measured at the COM port, with the corresponding channel (COM to NO or COM to NC) in the ON state and the output ( NC or NO ) open |
| $\mathrm{I}_{\text {COM (OFF) }}$ | Leakage current measured at the COM port during the power-down condition, $\mathrm{V}_{+}=0$ |
| $I_{\text {com(PWROFF) }}$ | Leakage current measured th the COM port during the power-down condition, $\mathrm{V}_{+}=0$. |
| $\mathrm{V}_{\mathrm{IH}}$ | Minimum input voltage for logic high for the control input (IN) |
| $\mathrm{V}_{\text {IL }}$ | Maximum input voltage for logic low for the control input (IN) |
| $\mathrm{V}_{1}$ | Voltage at the control input (IN) |
| $\mathrm{I}_{\mathrm{H}}, \mathrm{I}_{\text {IL }}$ | Leakage current measured at the control input (IN) |
| $\mathrm{t}_{\mathrm{on}}$ | Turn-on time for the switch. This parameter is measured under the specified range of conditions and by the propagation delay between the digital control ( IN ) signal and analog output (COM or NO ) signal when the switch is turning ON. |
| toff | Turn-off time for the switch. This parameter is measured under the specified range of conditions and by the propagation delay between the digital control (IN) signal and analog output (COM or NO) signal when the switch is turning OFF. |
| $t_{\text {BBM }}$ | Break-before-make time. This parameter is measured under the specified range of conditions and by the propagation delay between the output of two adjacent analog channels ( NC and NO ) when the control signal changes state. |
| $Q_{C}$ | Charge injection is a measurement of unwanted signal coupling from the control (IN) input to the analog (NO or COM) output. This is measured in coulomb (C) and measured by the total charge induced due to switching of the control input.Charge injection, $Q_{C}=C_{L} \times \Delta V_{C O M}, C_{L}$ is the load capacitance and $\Delta V_{C O M}$ is the change in analog output voltage. |
| $\mathrm{C}_{\mathrm{NO} \text { (OFF) }}$ | Capacitance at the NO port when the corresponding channel (NO to COM) is OFF |
| $\mathrm{C}_{\mathrm{NO}(\mathrm{ON})}$ | Capacitance at the NO port when the corresponding channel (NO to COM) is ON |
| $\mathrm{C}_{\text {COM(ON) }}$ | Capacitance at the COM port when the corresponding channel (COM to NO) is ON |
| $\mathrm{C}_{\text {Com(OFF) }}$ | Capacitance at the COM port when the corresponding channel (COM to NO) is OFF |
| $\mathrm{Cl}_{1}$ | Capacitance of control input (IN) |
| $\mathrm{O}_{\text {ISo }}$ | OFF isolation of the switch is a measurement of OFF-state switch impedance. This is measured in dB in a specific frequency, with the corresponding channel ( NC to COM or NO to COM) in the OFF state. |
| $\mathrm{X}_{\text {TALK }}$ | Crosstalk is a measurement of unwanted signal coupling from an ON channel to an OFF channel (NC to NO or NO to NC). This is measured in a specific frequency and in dB. |
| BW | Bandwidth of the switch. This is the frequency in which the gain of an ON channel is -3 dB below the DC gain. |

PARAMETER DESCRIPTION (continued)

| SYMBOL | DESCRIPTION |
| :---: | :--- |
| THD | Total harmonic distortion describes the signal distortion caused by the analog switch. This is defined as the ratio of root <br> mean square (RMS) value of the second, third, and higher harmonic to the absolute magnitude of the fundamental <br> harmonic. |
| $\mathrm{I}_{+}$ | Static power-supply current with the control (IN) pin at $\mathrm{V}_{+}$or GND |

PARAMETER MEASURMENT INFORMATION


Figure 19. ON-State Resistance ( $\mathrm{r}_{\mathrm{on}}$ )


Figure 20. OFF-State Leakage Current (INC(OFF), $\left.I_{\text {NO(OFF) }}, I_{\text {NO(PWROFF) }}, I_{\text {COM(OFF) }}, I_{\text {Com(PWROFF) }}\right)$


Figure 21. ON-State Leakage Current (ICOM(ON), $\left.I_{\mathrm{NO}(\mathrm{ON})}\right)$

## PARAMETER MEASURMENT INFORMATION (continued)



Figure 22. Capacitance ( $\left.\mathrm{C}_{\mathrm{l}}, \mathrm{C}_{\mathrm{COM}(\mathrm{ON})}, \mathrm{C}_{\mathrm{NO}(\mathrm{OFF})}, \mathrm{C}_{\mathrm{COM}(\mathrm{OFF})}, \mathrm{C}_{\mathrm{NO}(\mathrm{ON})}\right)$

A. All input pulses are supplied by generators having the following characteristics: $\mathrm{PRR} \leq 10 \mathrm{MHz}, \mathrm{ZO}=50 \Omega, \mathrm{t}_{\mathrm{r}}<5 \mathrm{~ns}$, $\mathrm{t}_{\mathrm{f}}<5 \mathrm{~ns}$.
B. $C_{L}$ includes probe and jig capacitance.

Figure 23. Turn-On (ton) and Turn-Off Time (toff)

## PARAMETER MEASURMENT INFORMATION (continued)


A. All input pulses are supplied by generators having the following characteristics: PRR $\leq 10 \mathrm{MHz}, \mathrm{ZO}=50 \Omega$, $\mathrm{t}_{\mathrm{r}}<5 \mathrm{~ns}$, $\mathrm{t}_{\mathrm{f}}<5 \mathrm{~ns}$.
B. $\quad \mathrm{C}_{\mathrm{L}}$ includes probe and jig capacitance.

Figure 24. Break-Before-Make Time ( $\mathrm{t}_{\mathrm{BB}}$ )


Figure 25. Bandwidth (BW)

## PARAMETER MEASURMENT INFORMATION (continued)



Figure 26. OFF Isolation ( $\mathrm{O}_{\mathrm{ISO}}$ )


Figure 27. Crosstalk ( $\mathrm{X}_{\text {TALK }}$ )

PARAMETER MEASURMENT INFORMATION (continued)

A. All input pulses are supplied by generators having the following characteristics: $\mathrm{PRR} \leq 10 \mathrm{MHz}, \mathrm{ZO}=50 \Omega, \mathrm{t}_{\mathrm{r}}<5 \mathrm{~ns}$, $\mathrm{t}_{\mathrm{f}}<5 \mathrm{~ns}$.
B. $C_{L}$ includes probe and jig capacitance.

Figure 28. Charge Injection $\left(Q_{C}\right)$

A. $C_{L}$ includes probe and jig capacitance.

Figure 29. Total Harmonic Distortion (THD)

## PACKAGING INFORMATION

| Orderable Device | Status <br> (1) | Package Type | Package Drawing | Pins | Package Qty | $\begin{gathered} \text { Eco Plan } \\ \text { (2) } \end{gathered}$ | Lead/Ball Finish | MSL Peak Temp <br> (3) | Op Temp ( ${ }^{\circ} \mathrm{C}$ ) | Device Marking <br> (4/5) | Samples |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| TS5A3359DCUR | ACTIVE | US8 | DCU | 8 | 3000 | $\begin{gathered} \text { Green (RoHS } \\ \& \text { no Sb/Br) } \end{gathered}$ | CU NIPDAU | Level-1-260C-UNLIM | -40 to 85 | $\begin{aligned} & \text { (AL ~JALR) } \\ & \mathrm{JZ} \end{aligned}$ | Samples |
| TS5A3359DCURE4 | ACTIVE | US8 | DCU | 8 | 3000 | $\begin{aligned} & \text { Green (RoHS } \\ & \text { \& no Sb/Br) } \end{aligned}$ | CU NIPDAU | Level-1-260C-UNLIM | -40 to 85 | $\begin{aligned} & \text { (AL ~JALR) } \\ & \mathrm{JZ} \end{aligned}$ | Samples |
| TS5A3359DCURG4 | ACtive | US8 | DCU | 8 | 3000 | Green (RoHS \& no $\mathrm{Sb} / \mathrm{Br}$ ) | CU NIPDAU | Level-1-260C-UNLIM | -40 to 85 | $\begin{aligned} & \text { (AL ~JALR) } \\ & \mathrm{JZ} \\ & \hline \end{aligned}$ | Samples |
| TS5A3359DCUT | ACTIVE | US8 | DCU | 8 | 250 | Green (RoHS \& no $\mathrm{Sb} / \mathrm{Br}$ ) | CU NIPDAU | Level-1-260C-UNLIM | -40 to 85 | $\begin{aligned} & \text { (AL ~JALR) } \\ & J Z \end{aligned}$ | Samples |
| TS5A3359DCUTE4 | ACTIVE | US8 | DCU | 8 | 250 | Green (RoHS \& no $\mathrm{Sb} / \mathrm{Br}$ ) | CU NIPDAU | Level-1-260C-UNLIM | -40 to 85 | $\begin{aligned} & \hline \text { (AL ~JALR) } \\ & J Z \end{aligned}$ | Samples |
| TS5A3359DCUTG4 | ACTIVE | US8 | DCU | 8 | 250 | TBD | Call TI | Call TI | -40 to 85 | $\begin{aligned} & \hline \text { (AL } \sim J A L R) ~ \\ & J Z \end{aligned}$ | Samples |
| TS5A3359YZPR | ACTIVE | DSBGA | YZP | 8 | 3000 | Green (RoHS \& no $\mathrm{Sb} / \mathrm{Br}$ ) | SNAGCU | Level-1-260C-UNLIM | -40 to 85 | J97 | Samples |
| TS5A3359YZPRB | LIFEBUY | DSBGA | YZP | 8 |  | Green (RoHS \& no $\mathrm{Sb} / \mathrm{Br}$ ) | SNAGCU | Level-1-260C-UNLIM |  | J97 |  |

${ }^{(1)}$ The marketing status values are defined as follows:
ACTIVE: Product device recommended for new designs.
LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.
NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.
PREVIEW: Device has been announced but is not in production. Samples may or may not be available.
OBSOLETE: TI has discontinued the production of the device.
${ }^{(2)}$ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS \& no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.
TBD: The Pb-Free/Green conversion plan has not been defined.
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${ }^{(3)}$ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

## ${ }^{(4)}$ There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

${ }^{(5)}$ Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

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## TAPE AND REEL INFORMATION


*All dimensions are nominal

| Device | Package <br> Type | Package <br> Drawing | Pins | SPQ | Reel <br> Diameter <br> $(\mathbf{m m})$ | Reel <br> Width <br> $\mathbf{W 1}(\mathbf{m m})$ | A0 <br> $(\mathbf{m m})$ | B0 <br> $(\mathbf{m m})$ | K0 <br> $(\mathbf{m m})$ | P1 <br> $(\mathbf{m m})$ | W <br> $(\mathbf{m m})$ | Pin1 <br> Quadrant |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| TS5A3359DCUR | US8 | DCU | 8 | 3000 | 180.0 | 8.4 | 2.25 | 3.35 | 1.05 | 4.0 | 8.0 | Q3 |
| TS5A3359YZPR | DSBGA | YZP | 8 | 3000 | 180.0 | 8.4 | 1.02 | 2.02 | 0.63 | 4.0 | 8.0 | Q1 |
| TS5A3359YZPRB | DSBGA | YZP | 8 | 0 | 180.0 | 8.4 | 1.02 | 2.02 | 0.63 | 4.0 | 8.0 | Q1 |


*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| TS5A3359DCUR | US8 | DCU | 8 | 3000 | 202.0 | 201.0 | 28.0 |
| TS5A3359YZPR | DSBGA | YZP | 8 | 3000 | 220.0 | 220.0 | 34.0 |
| TS5A3359YZPRB | DSBGA | YZP | 8 | 0 | 220.0 | 220.0 | 34.0 |

DCU (R-PDSO-G8)


NOTES: A. All linear dimensions are in millimeters.
B. This drawing is subject to change without notice.
C. Body dimensions do not include mold flash or protrusion. Mold flash and protrusion shall not exceed 0.15 per side.
D. Falls within JEDEC MO-187 variation CA.

DCU (S-PDSO-G8)
PLASTIC SMALL OUTLINE PACKAGE (DIE DOWN)


NOTES: A. All linear dimensions are in millimeters.
B. This drawing is subject to change without notice.
C. Publication IPC-7351 is recommended for alternate designs.
D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.

YZP (R-XBGA-N8)


NOTES: A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.
B. This drawing is subject to change without notice.
C. NanoFree ${ }^{\text {TM }}$ package configuration.

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